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- Meets or Exceeds the Requirements of ANSI Standards EIA/TIA-422-B, EIA/TIA-423-B, RS-485, and ITU Recommendations V.10 and V.11.
- Designed to Operate With Pulse Durations as Short as 20 ns
- Designed for Multipoint Bus Transmission on Long Bus Lines in Noisy Environments
- Input Sensitivity . . . ±200 mV
- Low-Power Consumption . . . 20 mA Max
- Open-Circuit Fail-Safe Design
- Pin Compatible With SN75173 and AM26LS32

#### **DORNPACKAGE** (TOP VIEW) 16 V<sub>CC</sub> 1B L 1A [ 2 15 4B 3 14 **1** 4A 1Y [ 4 13 4Y G [] 5 12 G 2Y [ 6 11 7 3Y 2А Г 2B 🛚 7 10 3A 9 🛮 3B GND L

#### description

The SN65LBC173 and SN75LBC173 are monolithic quadruple differential line receivers with 3-state outputs. Both are designed to meet the requirements of the ANSI standards EIA/TIA-422-B, EIA/TIA-423-B, RS-485, and ITU Recommendations V.10 and V.11. The devices are optimized for balanced multipoint bus transmission at data rates up to and exceeding 10 million bits per second. The four receivers share two ORed enable inputs, one active when high, the other active when low.

Each receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ±200 mV over a common-mode input voltage range of 12 V to −7 V. Fail-safe design ensures that if the inputs are open circuited, the output is always high. Both devices are designed using the Texas Instruments proprietary LinBiCMOS™ technology that provides low power consumption, high switching speeds, and robustness.

These devices offer optimum performance when used with the SN75LBC172 or SN75LBC174 quadruple line drivers. The SN65LBC173 and SN75LBC173 are available in the 16-pin DIP (N) and SOIC (D) packages.

The SN65LBC173 is characterized over the industrial temperature range of –40°C to 85°C. The SN75LBC173 is characterized for operation over the commercial temperature range of 0°C to 70°C.

FUNCTION TABLE (each receiver)

DIFFERENTIAL INPUTS A-B	ENAI	BLES	OUTPUT
	G	G	Y
V <sub>ID</sub> ≥ 0.2 V	H	X	H
	X	L	H
-0.2 V < V <sub>ID</sub> < 0.2 V	H X	X L	?
V <sub>ID</sub> ≤ −0.2 V	H	X	L
	X	L	L
X	L	Н	Z
Open Circuit	H	X	H
	X	L	H

H = high level, L = low level, X = irrelevantZ = high impedance (off), ? = indeterminate



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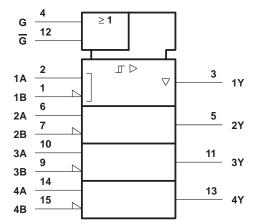
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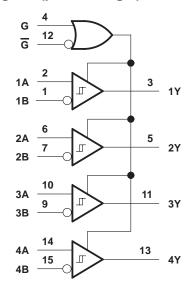
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### logic symbol†

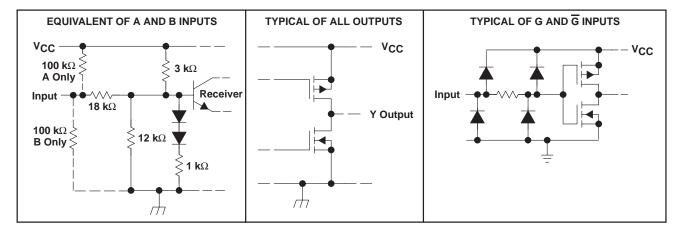


<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



## schematics of inputs and outputs



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub> (see Note 1)	0.3 V to 7 V
Input voltage, V <sub>I</sub> (A or B inputs)	±25 V
Differential input voltage, V <sub>ID</sub> (see Note 2)	±25 V
Voltage range at Y, G, G	$\dots$ -0.3 V to V <sub>CC</sub> + 0.5 V
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub> : SN65LBC173	40°C to 85°C
SN75LBC173	0°C to 70°C
Storage temperature range, T <sub>stq</sub>	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### **DISSIPATION RATING TABLE**

$\begin{array}{c} \text{PACKAGE} & \text{$T_A \leq 25^{\circ}$C} \\ \text{POWER RATING} \end{array}$		DERATING FACTOR	T <sub>A</sub> = 70°C	T <sub>A</sub> = 85°C	
		ABOVE T <sub>A</sub> = 25°C	POWER RATING	POWER RATING	
D	1100 mW	8.7 mW/°C	708 mW	578 mW	
N	1150 mW	9.2 mW/°C	736 mW	598 mW	

### recommended operating conditions

			MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>			4.75	5	5.25	V
Common-mode input voltage, V <sub>IC</sub>			-7		12	V
Differential input voltage, V <sub>ID</sub>					±6	V
High-level input voltage, VIH	Cipputo	G inputs				V
Low-level input voltage, V <sub>IL</sub>	G iriputs				0.8	V
High-level output current, IOH					-8	mA
Low-level output current, I <sub>OL</sub>				16	mA	
Operating free-air temperature, TA	SN65LBC17	3	-40		85	°C
	SN75LBC17	3	0		70	



NOTES: 1. All voltage values are with respect to GND.

<sup>2.</sup> Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

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# electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP <sup>†</sup>	MAX	UNIT	
VIT+	Positive-going input three	shold voltage	IO = -8  mA					0.2	V
VIT-	Negative-going input three	shold voltage	I <sub>O</sub> = 16 mA			-0.2			V
V <sub>hys</sub>	Hysteresis voltage (V <sub>IT+</sub>	. – V <sub>IT</sub> _)					45		mV
VIK	Enable input clamp voltage	ge	I <sub>I</sub> = -18 mA				-0.9	-1.5	V
Vон	High-level output voltage		$V_{ID} = 200 \text{ mV},$	I <sub>OH</sub> = -8 m/	A	3.5	4.5		V
VOL	Low-level output voltage		$V_{ID} = -200 \text{ mV},$	I <sub>OL</sub> = 16 mA	\		0.3	0.5	V
loz	High-impedance-state ou	tput current	$V_O = 0 V \text{ to } V_{CC}$					±20	μΑ
			V <sub>IH</sub> = 12 V,	V <sub>CC</sub> = 5 V,	Other inputs at 0 V		0.7	1	mA
l	Bus input current	A or B inputs	V <sub>IH</sub> = 12 V,	$V_{CC} = 0 V$	Other inputs at 0 V		0.8	1	mA
'1	Bus input current	A of B iliputs	$V_{IH} = -7 V$ ,	V <sub>CC</sub> = 5 V,	Other inputs at 0 V		-0.5	-0.8	mA
			$V_{IH} = -7 V$ ,	$V_{CC} = 0 V$	Other inputs at 0 V		-0.4	-0.8	mA
lιΗ	High-level input current		V <sub>IH</sub> = 5 V					±20	μΑ
I <sub>I</sub> L	Low-level input current		V <sub>IL</sub> = 0 V					-20	μΑ
IOS	Short-circuit output curre	nt	V <sub>O</sub> = 0				-80	-120	mA
loo	Supply current		Outputs enabled,	$I_{O} = 0$ ,	V <sub>ID</sub> = 5 V		11	20	mA
Licc	ICC Supply current		Outputs disabled				0.9	1.4	IIIA

 $<sup>\</sup>dagger$  All typical values are at V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

## switching characteristics, $V_{CC}$ = 5 V, $C_L$ = 15 pF, $T_A$ = 25°C

PARAMETER TEST CONDITIONS				TYP	MAX	UNIT
tPHL	Propagation delay time, high- to low-level output	V <sub>ID</sub> = -1.5 V to 1.5 V, See Figure 1	11	22	30	ns
<sup>t</sup> PLH	Propagation delay time, low- to high-level output	V D = -1.5 V to 1.5 V,	11	22	30	ns
<sup>t</sup> PZH	Output enable time to high level	See Figure 2		17	30	ns
tPZL	Output enable time to low level	See Figure 3		18	30	ns
tPHZ	Output disable time from high level	See Figure 2		35	45	ns
tPLZ	Output disable time from low level	See Figure 3		25	40	ns
t <sub>sk(p)</sub>	Pulse skew ( tpHL - tpLH )	See Figure 2		0.5	6	ns
t <sub>t</sub>	Transition time	See Figure 1		5	10	ns

#### PARAMETER MEASUREMENT INFORMATION

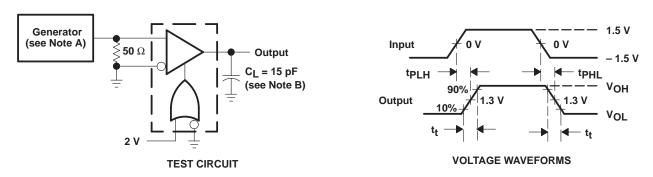
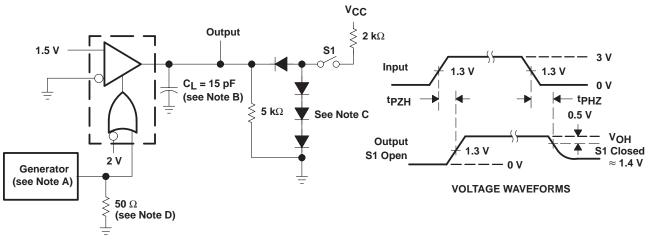


Figure 1. t<sub>pd</sub> and t<sub>t</sub> Test Circuit and Voltage Waveforms

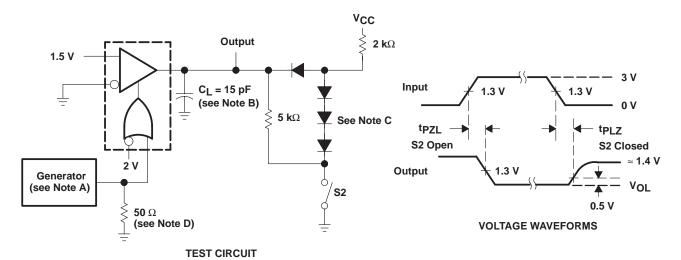


**TEST CIRCUIT** 

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_{f} \le 6$  ns,  $t_$ 
  - B. C<sub>I</sub> includes probe and jig capacitance.
  - C. All diodes are 1N916 or equivalent.
  - D. To test the active-low enable  $\overline{G}$ , ground G and apply an inverted input waveform to  $\overline{G}$ .

Figure 2. t<sub>PHZ</sub> and t<sub>PZH</sub> Test Circuit and Voltage Waveforms

#### PARAMETER MEASUREMENT INFORMATION

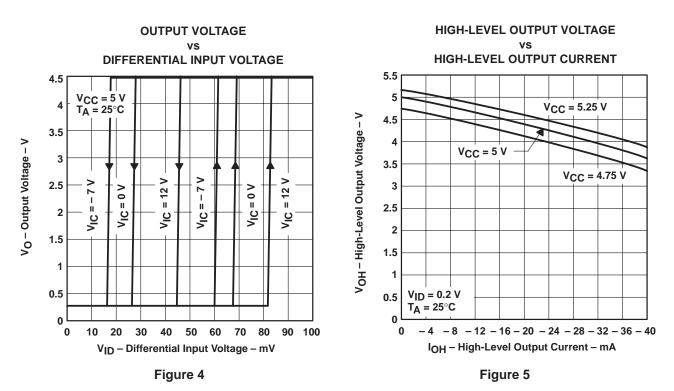


NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_{\Gamma} \le 6$  ns,  $t_$ 

- B. C<sub>L</sub> includes probe and jig capacitance.
- C. All diodes are 1N916 or equivalent.
- D. To test the active-low enable  $\overline{G}$ , ground G and apply an inverted input waveform to  $\overline{G}$ .

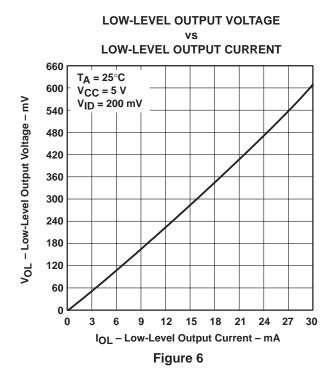
Figure 3.  $t_{\mbox{\scriptsize PZL}}$  and  $t_{\mbox{\scriptsize PLZ}}$  Test Circuit and Voltage Waveforms

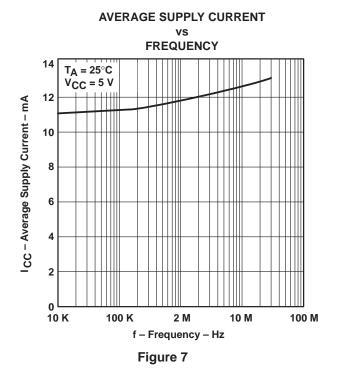
### TYPICAL CHARACTERISTICS



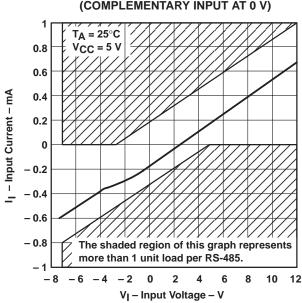


#### **TYPICAL CHARACTERISTICS**









FREE-AIR TEMPERATURE 24.5 V<sub>CC</sub> = 5 V  $C_L = 15 pF$  $V_{10} = \pm 1.5 \text{ V}$ 24 Propagation Delay Time - ns **tPHL** 23.5 23 <sup>t</sup>PLH 22.5 22 **– 40** - 20 20 60 100 T<sub>A</sub> - Free-Air Temperature - °C

PROPAGATION DELAY TIME

Figure 8 Figure 9

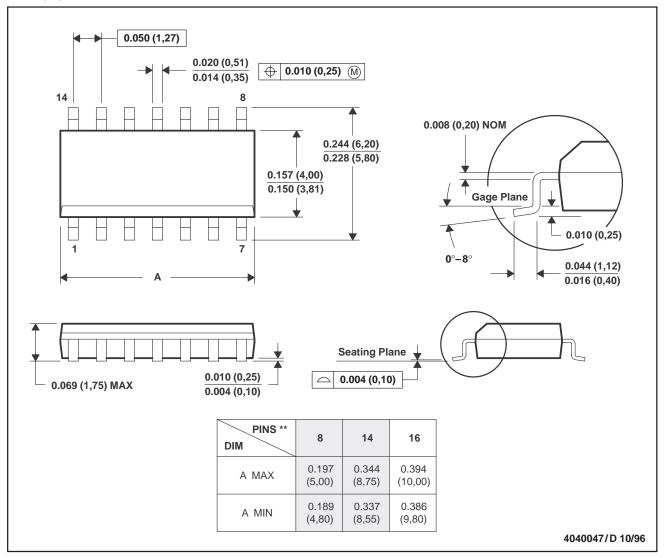
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#### **MECHANICAL DATA**

### D (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 14 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012

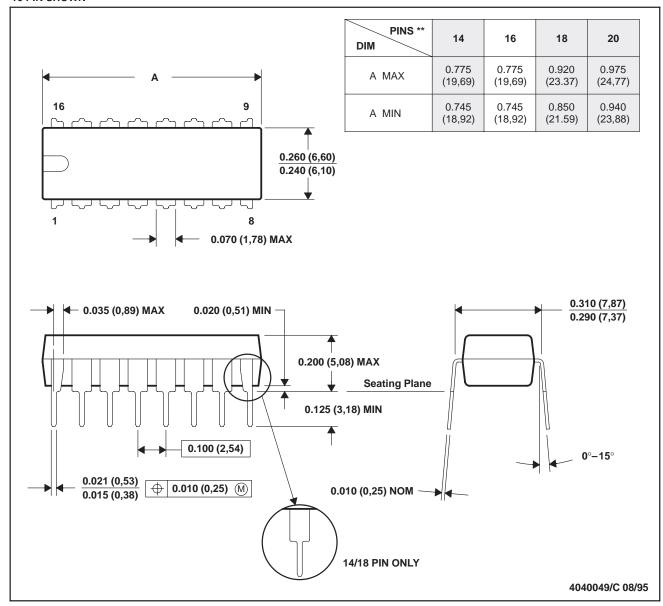
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#### **MECHANICAL DATA**

### N (R-PDIP-T\*\*)

#### PLASTIC DUAL-IN-LINE PACKAGE

#### **16 PIN SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001 (20 pin package is shorter then MS-001.)

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